### PATENT ASSIGNMENT

## Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Bernd Karl APPELT	10/01/2009
William T. CHEN	10/01/2009
Calvin CHEUNG	10/01/2009
Shih-Fu HUANG	10/01/2009
Yuan-Chang SU	10/01/2009
Chia-Cheng CHEN	10/01/2009
Ta-Chiun LEE	10/01/2009

#### **RECEIVING PARTY DATA**

Name:	Advanced Semiconductor Engineering, Inc.	
Street Address:	No. 26, Jingsan Rd.	
Internal Address:	Nantz Chiu	
City:	Kaohsiung	
State/Country:	TAIWAN	
Postal Code:	811	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12562950

#### **CORRESPONDENCE DATA**

Fax Number: (703)621-7155

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 703 621 7140

Email: mpe@mg-ip.com

Correspondent Name: Joe McKinney Muncy

Address Line 1: P.O. Box 1364

Address Line 4: Fairfax, VIRGINIA 22038

ATTORNEY DOCKET NUMBER: 4448/0336PUS1

500999765 PATENT
REEL: 023434 FRAME: 0097

)P \$40,00 12562

NAME OF SUBMITTER:	Joe McKinney Muncy
Total Attachments: 2 source=2009-10-28-Assignment#page1.tif source=2009-10-28-Assignment#page2.tif	

PATENT REEL: 023434 FRAME: 0098

## ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

Page 1 of 2

WHEREAS	Bernd Karl Appelt, William T Chen, Calvin Cheung, Shih-Fu Huang, Yuan-Chang Su, Chia-Cheng
	Chen and Ta-Chun Lee
hereinafter referr	ed to collectively as the assignor, has invented a certain improvement relating to
SUBSTRATE HA	AVING SINGLE PATTERNED METAL LAYER, AND PACKAGE APPLIED WITH THE SUBSTRATE, AND
METHODS OF N	IANUFACTURING OF THE SUBSTRATE AND PACKAGE
[ ] the inventor	's declaration for said application being executed concurrently with the execution of this instrument; said
application to be	filed in the United States Patent and Trademark Office;
[ imes] said applica	ation having been filed in the United States Patent and Trademark Office on September 18, 2009,
authorization bei	ng hereby given to my attorneys, Customer No. 60601, to insert here in parentheses (Application Serial No.
12/562,950) the a	application serial number of said application when known;
[ ] said applic	ation having been filed under the Patent Cooperation Treaty on,
Serial No	the United States of America being designated.

AND WHEREAS Advanced Semiconductor Engineering, Inc. of No.26, Jingsan Rd., Nantz Chiu, Kaohsiung, Taiwan 811, R.O.C., hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

日月光編號 ASE2238 || 三達編號 US5526PA

PATENT REEL: 023434 FRAME: 0099

# ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT Page 2 of 2

ASSIGNOR:		ASSIGNOR:	
Signature:	part la R	Signature:	WI.C.
Printed Name:	Bernd Karl Appelt	Printed Name:	William T Chen
Date:	October 1, 2009	Date:	October 1, 2009
ASSIGNOR:	0.4	ASSIGNOR:	
Signature:	Cali Ching_	Signature:	Shih - Fu Huang
Printed Name:	Calvin Cheung	Printed Name:	Shih-Fu Huang
Date:	October 1, 2009	Date:	October 1, 2009
ASSIGNOR:		ASSIGNOR:	
ASSIGNOR:	Yuan-Chang Sy	ASSIGNOR:	chia-chong chan
Signature:	Yuan-Chang Sy Yuan-Chang Su		Chia-Chong Chan Chia-Cheng Chen
Signature:	V	Signature:	V
Signature: Printed Name:	Yuan-Chang Su	Signature: Printed Name:	Chia-Cheng Chen
Signature: Printed Name:	Yuan-Chang Su	Signature: Printed Name:	Chia-Cheng Chen
Signature: Printed Name: Date:	Yuan-Chang Su	Signature: Printed Name: Date:	Chia-Cheng Chen
Signature: Printed Name: Date:  ASSIGNOR:	Yuan-Chang Su  October 1, 2009	Signature:  Printed Name:  Date:  Witness:	Chia-Cheng Chen

日月光編號 ASE2238 || 三達編號 US5526PA

PATENT REEL: 023434 FRAME: 0100

**RECORDED: 10/28/2009**